

**Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-180	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-140	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	V
Continuous Collector Current	I <sub>C</sub>	-4	A
Peak Pulse Current	I <sub>CM</sub>	-10	A

**Thermal Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

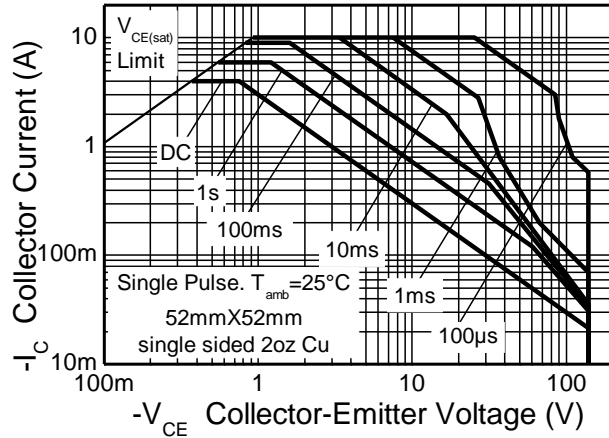
Characteristic	Symbol	Value	Unit
Power Dissipation	P <sub>D</sub>	3.0	W
		2.0	
		1.6	
		1.2	
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub>	41.7	°C/W
		62.5	
		78.1	
		104	
Thermal Resistance Junction to Lead	R <sub>θJL</sub>	10.5	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

**ESD Ratings** (Note 10)

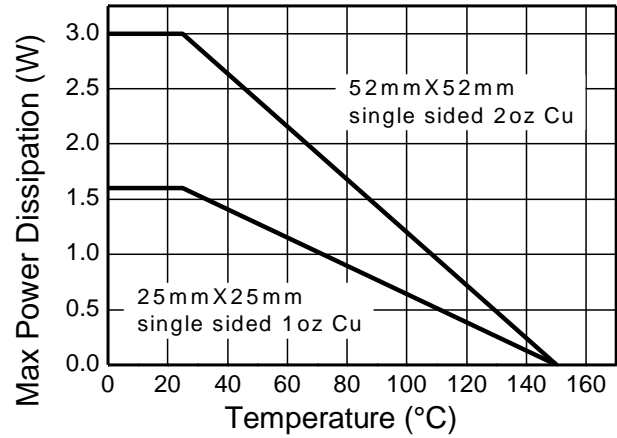
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	8,000	V	3B
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

- Notes:
- For a device mounted with the collector lead on 52mm x 52mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
  - Same as Note 5, except the device is mounted on 25mm x 25mm 2oz copper.
  - Same as Note 5, except the device is mounted on 25mm x 25mm 1oz copper.
  - Same as Note 5, except the device is mounted on minimum recommended pad layout.
  - Thermal resistance from junction to solder-point (at the end of the collector lead).
  - Refer to JEDEC specification JESD22-A114 and JESD22-A115.

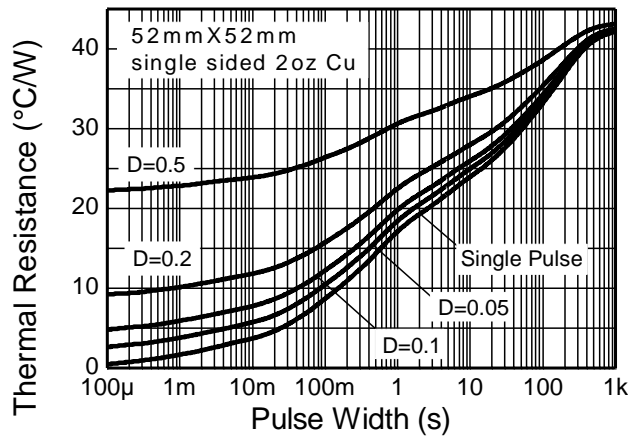
## Thermal Characteristics and Derating Information



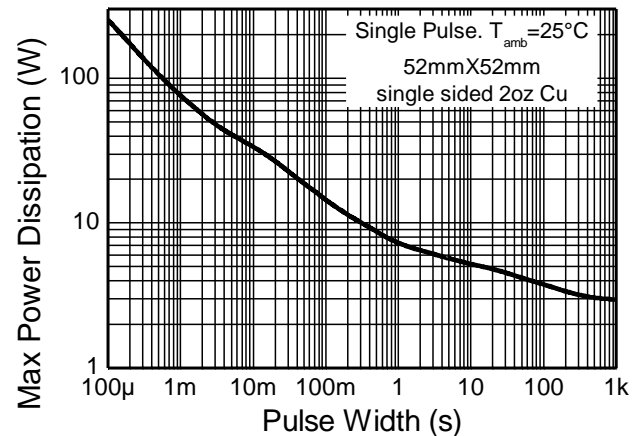
**Safe Operating Area**



**Derating Curve**



**Transient Thermal Impedance**



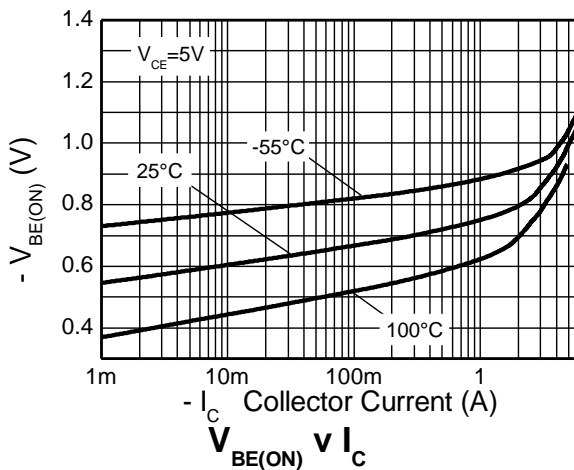
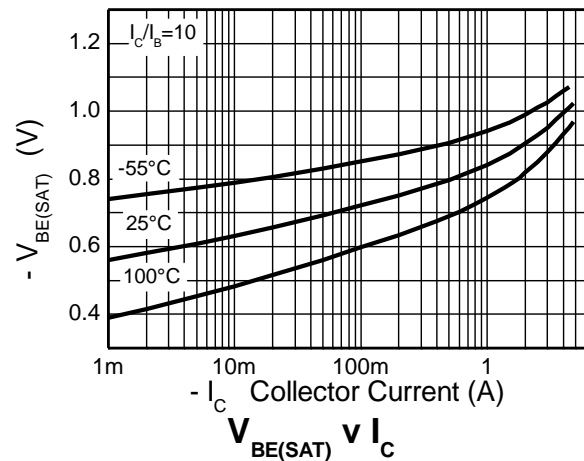
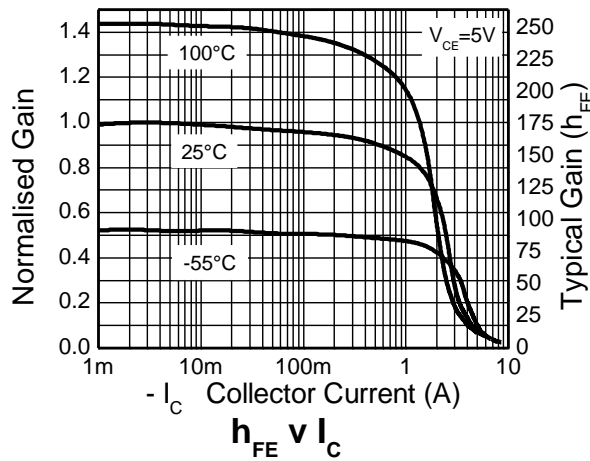
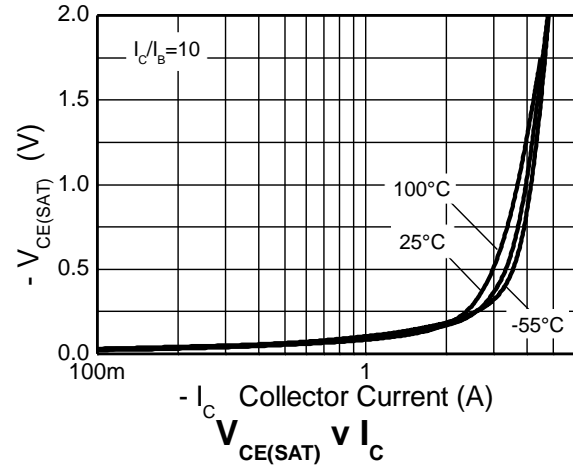
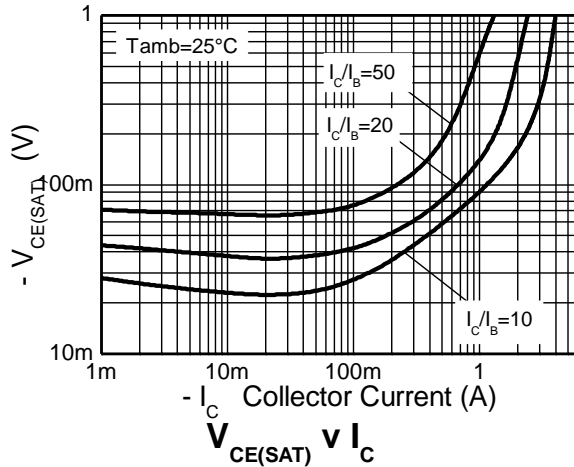
**Pulse Power Dissipation**

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ.	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-180	-200	-	V	I <sub>C</sub> = -100μA
Collector-Emitter Breakdown Voltage (Note 11)	BV <sub>CER</sub>	-180	-200	-	V	I <sub>C</sub> = -1μA, R <sub>B</sub> ≤ 1kΩ
Collector-Emitter Breakdown Voltage (Note 11)	BV <sub>CEO</sub>	-140	-160	-	V	I <sub>C</sub> = -1mA
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-7	-8.3	-	V	I <sub>E</sub> = -100μA
Collector Cut-Off Current	I <sub>CBO</sub>	-	< -1	-20	nA	V <sub>CB</sub> = -150V
		-	-	-500	nA	V <sub>CB</sub> = -150V, T <sub>A</sub> = +100°C
Collector Cut-Off Current	I <sub>CER</sub> R ≤ 1kΩ	-	< -1	-20	nA	V <sub>CB</sub> = -150V
		-	-	-500	nA	V <sub>CB</sub> = -150V, T <sub>A</sub> = +100°C
Emitter Cut-Off Current	I <sub>EBO</sub>	-	< -1	-10	nA	V <sub>EB</sub> = -6V
DC Current Transfer Static Ratio (Note 11)	h <sub>FE</sub>	100	225	-	-	I <sub>C</sub> = -10mA, V <sub>CE</sub> = -5V
		100	200	300		I <sub>C</sub> = -1A, V <sub>CE</sub> = -5V
		45	100	-		I <sub>C</sub> = -3A, V <sub>CE</sub> = -5V
		-	5	-		I <sub>C</sub> = -10A, V <sub>CE</sub> = -5V
Collector-Emitter Saturation Voltage (Note 11)	V <sub>CE(sat)</sub>	-	-40	-60	mV	I <sub>C</sub> = -100mA, I <sub>B</sub> = -5mA
		-	-55	-80		I <sub>C</sub> = -0.5A, I <sub>B</sub> = -50mA
		-	-85	-120		I <sub>C</sub> = -1A, I <sub>B</sub> = -100mA
		-	-275	-360		I <sub>C</sub> = -3A, I <sub>B</sub> = -300mA
Base-Emitter Saturation Voltage (Note 11)	V <sub>BE(sat)</sub>	-	-940	-1040	mV	I <sub>C</sub> = -3A, I <sub>B</sub> = -300mA
Base-Emitter Turn-On Voltage (Note 11)	V <sub>BE(on)</sub>	-	-830	-930	mV	I <sub>C</sub> = -3A, V <sub>CE</sub> = -5V
Transitional Frequency (Note 11)	f <sub>T</sub>	-	120	-	MHz	I <sub>C</sub> = -100mA, V <sub>CE</sub> = -10V, f = 50MHz
Output Capacitance	C <sub>obo</sub>	-	33	-	pF	V <sub>CB</sub> = -10V, f = 1MHz
Switching Time	t <sub>ON</sub>	-	42	-	ns	V <sub>CC</sub> = -50V, I <sub>C</sub> = -1A, I <sub>B1</sub> = -I <sub>B2</sub> = -100mA
	t <sub>OFF</sub>	-	636	-		

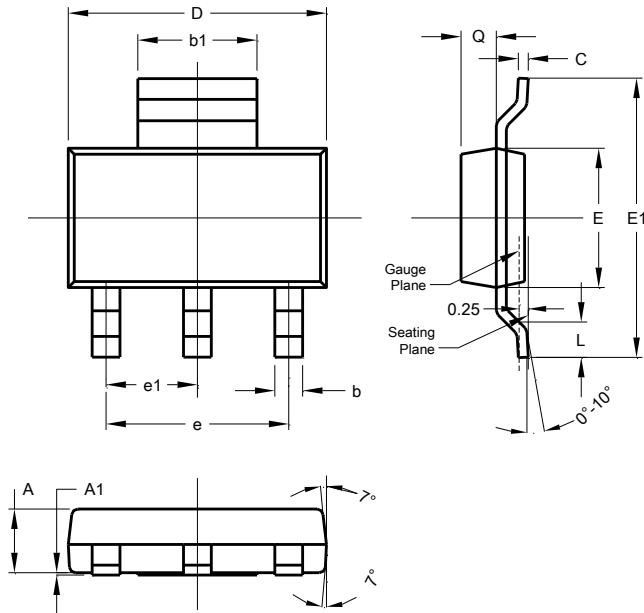
Note: 11. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

**Typical Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)



## Package Outline Dimensions

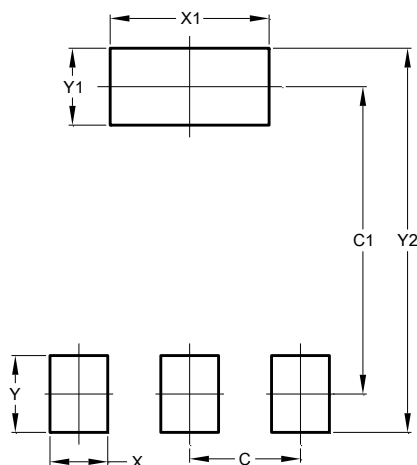
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



SOT223			
Dim	Min	Max	Typ
A	1.55	1.65	1.60
A1	0.010	0.15	0.05
b	0.60	0.80	0.70
b1	2.90	3.10	3.00
C	0.20	0.30	0.25
D	6.45	6.55	6.50
E	3.45	3.55	3.50
E1	6.90	7.10	7.00
e	-	-	4.60
e1	-	-	2.30
L	0.85	1.05	0.95
Q	0.84	0.94	0.89
All Dimensions in mm			

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00

For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.

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